

PRODUCT CHANGE NOTIFICATION

Title Notification of change in solder paste product.

Keywords Product Change Notification: Change in no clean and water soluble solder paste used in products assembled at Pletronics.

Article: **Products Affected: Circuit boards assembled at Pletronics Inc.**

Description and Purpose of solder paste change:

The solder paste currently used in production is being discontinued. They will be replaced with the recommended replacement from the manufacturer.

Oscillator performance will remain unchanged.

- The change does not affect form, fit and function of affected products
- Cleaning and test methods are unchanged
- This will be a running change as solder paste product is depleted
- Water Soluble

Alloy From Sn96.3Ag3.7 To Sn96.5Ag3.0Cu0.5

- No Clean

Alloy From Sn96.3Ag3.7 To Sn96.5Ag3.0Cu0.5

Pletronics Inc. certifies this is in accordance with the RoHS (2015/65/EC) and WEEE (2002/96/EC) directives.

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Created By Pletronics Engineering